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# HD74ALVC1G00

## 2-input NAND Gate

REJ03D0105-0600 Rev.6.00 Jun.20.2005

### **Description**

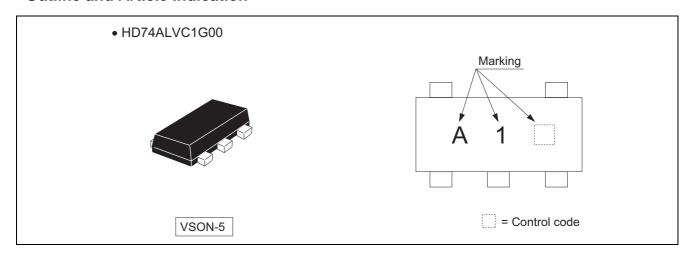
The HD74ALVC1G00 has two-input NAND gate in a 5 pin package. Low voltage and high-speed operation is suitable for the battery powered products (e.g., notebook computers), and the low power consumption extends the battery life.

#### **Features**

- The basic gate function is lined up as Renesas uni logic series.
- Supplied on emboss taping for high-speed automatic mounting.
- Supply voltage range: 1.2 to 3.6 V
   Operating temperature range: -40 to +85°C
- All inputs  $V_{IH}$  (Max.) = 3.6 V (@ $V_{CC}$  = 0 V to 3.6 V) All outputs  $V_{O}$  (Max.) = 3.6 V (@ $V_{CC}$  = 0 V)
- Output current  $\pm 2$  mA (@V<sub>CC</sub> = 1.2 V)  $\pm 4$  mA (@V<sub>CC</sub> = 1.4 V to 1.6 V)  $\pm 6$  mA (@V<sub>CC</sub> = 1.65 V to 1.95 V)  $\pm 18$  mA (@V<sub>CC</sub> = 2.3 V to 2.7 V)  $\pm 24$  mA (@V<sub>CC</sub> = 3.0 V to 3.6 V)
- Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74ALVC1G00VSE	VSON-5 pin	PUSN0005KA-A (TNP-5DV)	VS	E (3,000 pcs/reel)

#### **Outline and Article Indication**

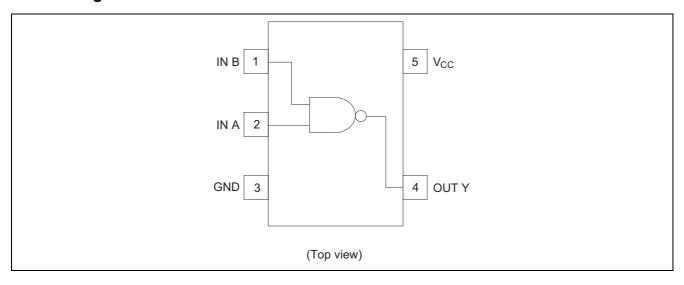


### **Function Table**

Inj	Inputs					
A	В	Y				
L	L	Н				
L	Н	Н				
Н	L	Н				
Н	Н	L				

H: High levelL: Low level

## **Pin Arrangement**



### **Absolute Maximum Ratings**

ltem	Symbol	Ratings	Unit	Test Conditions
Supply voltage range	V <sub>CC</sub>	-0.5 to 4.6	V	
Input voltage range *1	Vı	-0.5 to 4.6	V	
Output voltage range *1,2	Vo	-0.5 to V <sub>CC</sub> + 0.5	V	Output : H or L
		-0.5 to 4.6		V <sub>CC</sub> : OFF
Input clamp current	I <sub>IK</sub>	-50	mA	V <sub>1</sub> < 0
Output clamp current	I <sub>OK</sub>	±50	mA	$V_O < 0$ or $V_O > V_{CC}$
Continuous output current	I <sub>O</sub>	±50	mA	$V_O = 0$ to $V_{CC}$
Continuous current through V <sub>CC</sub> or GND	I <sub>CC</sub> or I <sub>GND</sub>	±100	mA	
Maximum power dissipation at Ta = 25°C (in still air) *3	P <sub>T</sub>	200	mW	
Storage temperature	Tstg	-65 to 150	°C	

Notes: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore no two of which may be realized at the same time.

- 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- 2. This value is limited to 4.6 V maximum.
- 3. The maximum package power dissipation was calculated using a junction temperature of 150°C.

## **Recommended Operating Conditions**

Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	$V_{CC}$	1.2	3.6	V	
Input voltage range	Vı	0	3.6	V	
Output voltage range	Vo	0	V <sub>CC</sub>	V	
Output current	Іон	_	-2	mA	V <sub>CC</sub> = 1.2 V
		_	-4		V <sub>CC</sub> = 1.4 V
		_	-6		V <sub>CC</sub> = 1.65 V
		_	-18		V <sub>CC</sub> = 2.3 V
		_	-24		V <sub>CC</sub> = 3.0 V
	l <sub>OL</sub>	_	2		V <sub>CC</sub> = 1.2 V
		_	4		V <sub>CC</sub> = 1.4 V
		_	6		V <sub>CC</sub> = 1.65 V
		_	18	1	V <sub>CC</sub> = 2.3 V
		_	24	1	V <sub>CC</sub> = 3.0 V
Input transition rise or fall rate	Δt / Δν	0	20	ns / V	V <sub>CC</sub> = 1.2 to 2.7 V
		0	10		V <sub>CC</sub> = 3.3±0.3 V
Operating free-air temperature	Та	-40	85	°C	

Note: Unused or floating inputs must be held high or low.

### **Electrical Characteristics**

 $Ta = -40 \text{ to } 85^{\circ}\text{C}$ 

Item	Symbol	V <sub>CC</sub> (V) *	Min	Тур	Max	Unit	Test condition
Input voltage	V <sub>IH</sub>	1.2	V <sub>CC</sub> ×0.75	_	_	V	
		1.4 to 1.6	V <sub>CC</sub> ×0.7	_	_		
		1.65 to 1.95	V <sub>CC</sub> ×0.7	_	_		
		2.3 to 2.7	1.7		_		
		3.0 to 3.6	2.0		_		
	$V_{IL}$	1.2	_		V <sub>CC</sub> ×0.25		
		1.4 to 1.6	_		V <sub>CC</sub> ×0.3		
		1.65 to 1.95	_	_	V <sub>CC</sub> ×0.3		
		2.3 to 2.7	_		0.7		
		3.0 to 3.6	_	_	0.8		
Output voltage	V <sub>OH</sub>	Min to Max	V <sub>CC</sub> -0.2		_	V	$I_{OH} = -100 \mu A$
		1.2	0.9		_		$I_{OH} = -2 \text{ mA}$
		1.4	1.1	_	_		$I_{OH} = -4 \text{ mA}$
		1.65	1.2		_		$I_{OH} = -6 \text{ mA}$
		2.3	1.7		_		$I_{OH} = -18 \text{ mA}$
		3.0	2.2	_	_		$I_{OH} = -24 \text{ mA}$
	$V_{OL}$	Min to Max	_		0.2		$I_{OL} = 100 \mu A$
		1.2	_		0.3		I <sub>OL</sub> = 2 mA
		1.4	_	_	0.3		$I_{OL} = 4 \text{ mA}$
		1.65	_		0.3		I <sub>OL</sub> = 6 mA
		2.3	_		0.55		I <sub>OL</sub> = 18 mA
		3.0	_		0.55		I <sub>OL</sub> = 24 mA
Input current	I <sub>IN</sub>	3.6	_	_	±5	μΑ	V <sub>IN</sub> = 3.6 V or GND
Quiescent	Icc	3.6	_		10	μΑ	$V_{IN} = V_{CC}$ or GND, $I_O = 0$
supply current							
Output leakage	I <sub>OFF</sub>	0	_	_	5	μΑ	$V_1$ or $V_0 = 0$ to 3.6 V
current							
Input capacitance	C <sub>IN</sub>	3.3	_	4.5	_	pF	$V_{IN} = V_{CC}$ or GND

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

## **Switching Characteristics**

### $V_{\rm CC} = 1.2 \ V$

		Ta = -40 to 85°C			Test	FROM	TO	
Item	Symbol	Min	Тур	Max	Unit	Conditions	(Input)	(Output)
Propagation delay time	t <sub>PLH</sub>	_	7.5	_	ns	$C_L = 15 pF$	A or B	Υ
	$t_PHL$							

## $V_{CC}=1.5\pm0.1~V$

		Ta = -40 to 85°C			Test	FROM	ТО	
Item	Symbol	Min	Тур	Max	Unit	Conditions	(Input)	(Output)
Propagation delay time	t <sub>PLH</sub> t <sub>PHL</sub>	2.0	_	7.0	ns	$C_L = 15 pF$	A or B	Υ

## $V_{CC}=1.8\pm0.15~V$

		Ta = -40 to 85°C			Test	FROM	ТО	
Item	Symbol	Min	Тур	Max	Unit	Conditions	(Input)	(Output)
Propagation delay time	t <sub>PLH</sub> t <sub>PHL</sub>	1.5	_	5.0	ns	C <sub>L</sub> = 30 pF	A or B	Υ

### $V_{CC}=2.5\pm0.2\ V$

		Ta = -40 to 85°C				Test	FROM	ТО
Item	Symbol	Min	Тур	Max	Unit	Conditions	(Input)	(Output)
Propagation delay time	t <sub>PLH</sub> t <sub>PHL</sub>	1.0	_	3.7	ns	$C_L = 30 pF$	A or B	Υ

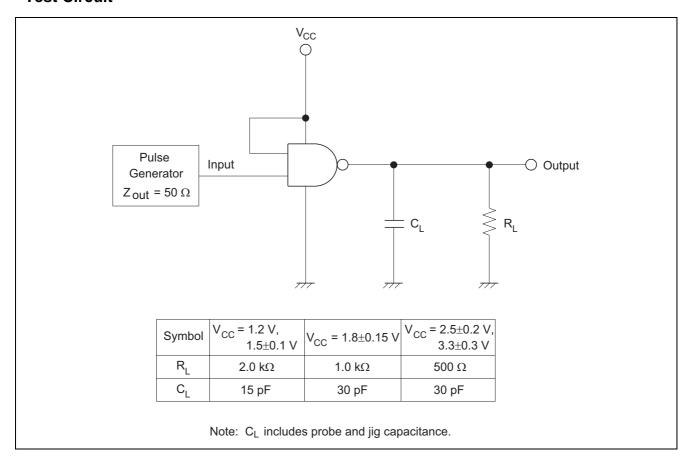
$$V_{CC} = 3.3 \pm 0.3 \text{ V}$$

		Ta = -40 to 85°C				Test	FROM	ТО
Item	Symbol	Min	Тур	Max	Unit	Conditions	(Input)	(Output)
Propagation delay time	t <sub>PLH</sub>	1.0	_	2.8	ns	$C_L = 30 pF$	A or B	Υ

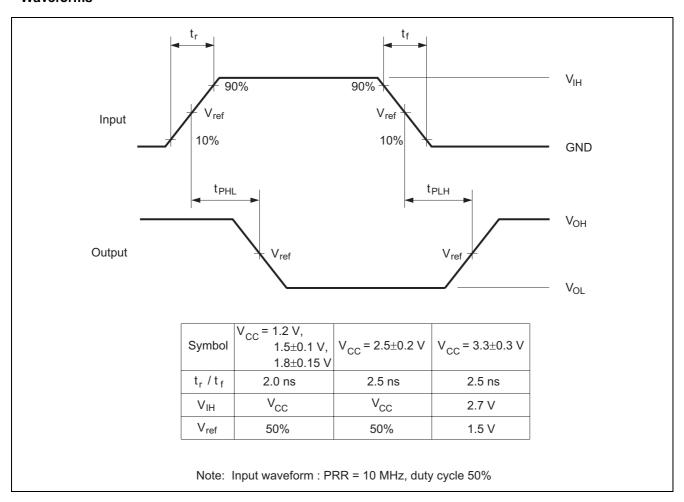
## **Operating Characteristics**

				Ta = 25°C			
Item	Symbol	V <sub>CC</sub> (V)	Min	Тур	Max	Unit	Test Conditions
Power dissipation	C <sub>PD</sub>	1.5	_	10.5	_	pF	f = 10 MHz
capacitance		1.8	_	10.5	_		
		2.5	_	10.5	_		
		3.3	_	11.5	_		

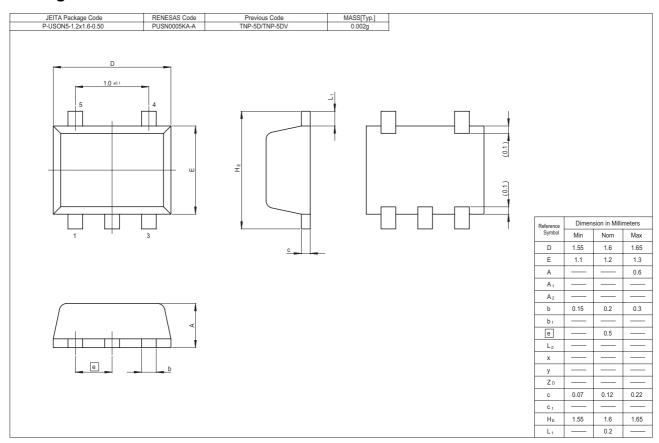
## **Test Circuit**



#### **Waveforms**



## **Package Dimensions**



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